SOLID STATE OPTRONICS

SMA4124

1 Form A
600V / 1A
MOSFET Output Solid State Relay

Description

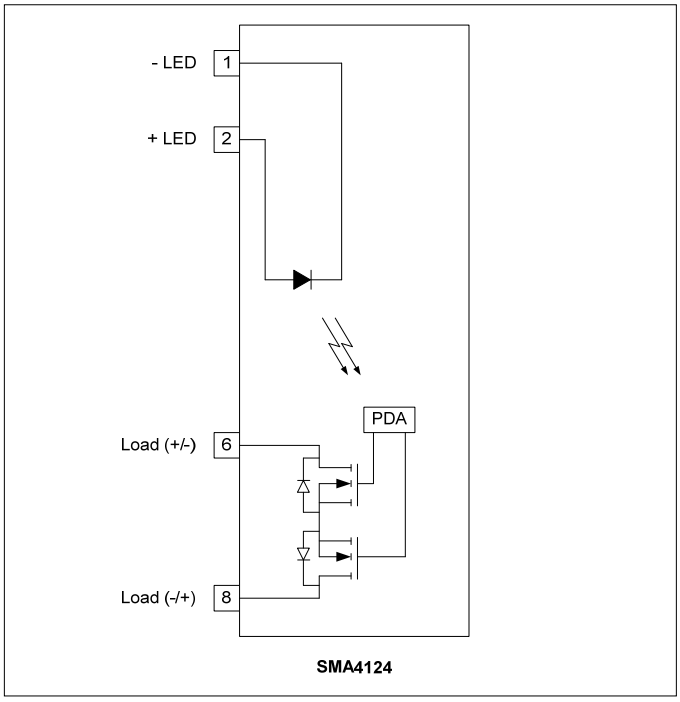
The SMA4124 is a single-pole, single-throw, normally open multipurpose solid state relay. The circuit is composed of an infra-red LED on the input side optically coupled to a Photo Diode Array which drives back-to-back high voltage enhancement type DMOS transistors on the output. The SMA4124 has a high blocking voltage (600V) and is rated for a continuous load current of 1A. The combination of high blocking voltage, high load current, and small form factor make the SMA4124 ideal for electromechanical and reed relay replacement.

The SMA4124 comes standard in a 4 pin SIP package.

Applications

- Reed Relay Replacement
- Mechanical Relay Replacement
- Medical Equipment
- Battery Monitoring
- Multiplexers
- Test Equipment

Schematic Diagram



SMA4124

Features

- High Blocking Voltage (600V MIN)
- High Load Current (1A MAX Continuous)
- Low Input Control Current (3mA TYP)
- Low On Resistance (1.3Ω TYP)
- High Input-to-Output Isolation (4kV)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL/C-UL:	File # E90096
VDE:	File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature	-55 to +125°C
Operating Temperature	-40 to +85°C
Continuous Input Current	50mA
Transient Input Current	500mA
Reverse Input Control Voltage	5V
Input Power Dissipation	40mW
Total Power Dissipation	1.2W
Solder Temperature – Wave (10sec)	260°C
Solder Temperature – IR Reflow (10sec)	260°C

Ordering Information

Part Number	Description
SMA4124	4 pin SIP, (25/Tube)

NOTE: Suffixes listed above are not included in marking on device for part number identification

Electrical Characteristics, T_A = 25°C (unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Input Specifications						
LED Forward Voltage	V_F	-	1.4	1.8	V	I_F = 10mA
LED Reverse Voltage	BV_R	5	-	-	V	I_R = 10µA
Input Reverse Current	I_R	-	-	10	µA	V_R = 6V
Turn-On Current	I_F	-	3	10	mA	I_O = 1A
Turn-Off Current	I_{FOFF}	-	0.5	-	mA	I_O = 1A
Output Specifications						
Blocking Voltage	V_B	600	-	-	V	I_F = 0mA, I_O = 1µA
Continuous Load Current	I_O	-	-	1	A	I_F = 10mA
Maximum Surge Current (non-repetitive)	$I_{O\ (SURGE)}$	-	-	5	A	I_F = 10mA, 1 second
On Resistance	R_{ON}	-	1.3	2	Ω	I_F = 10mA, I_O = 1A
Leakage Current	I_{Oleak}	-	0.1	1	µA	I_F = 0mA, V_O = 600V
Output Capacitance	C_{OUT}	-	20	-	pF	V_O=25V, f=1.0MHz
Offset Voltage	V_{OFFSET}	-	-	0.2	mV	I_F = 10mA
Coupled Specifications						
Turn-On Time	T_{ON}	-	2.5	5	mS	I_F = 10mA, I_O = 1A, V_O = 5V
Turn-Off Time	T_{OFF}	-	0.1	1	mS	I_F = 0mA, I_O = 1A, V_O = 5V
Coupled Capacitance	$C_{COUPLED}$	-	2	-	pF	
Contact Transient Ratio	-	2,000	7,000	0	V/µS	dV = 50V
Isolation Specifications						
Isolation Voltage	V_{ISO}	4000	-	-	V_{RMS}	RH ≤ 50%, t=1min
Input-Output Resistance	R_{I-O}	-	10^{12}	-	Ω	V_{I-O} = 500V_{DC}

SMA4124 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)

Figure 1: *Typical Turn-On Time Distribution* (N = 100, T_a = 25ºC)

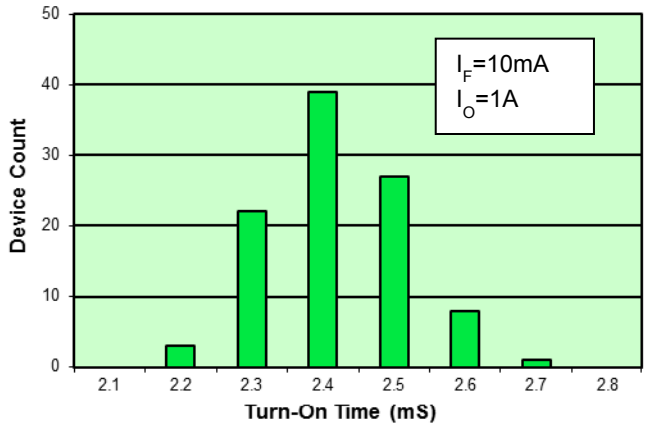


Figure 2: *Typical Turn-Off Time Distribution* (N = 100, T_a = 25ºC)

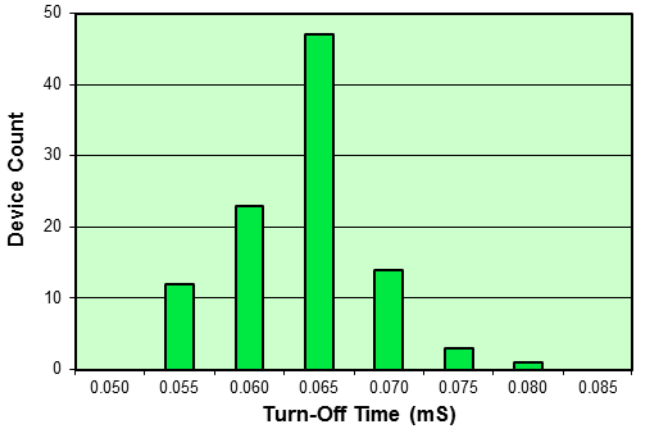


Figure 3: *Typical On-Resistance Distribution* (N = 100, T_a = 25ºC)

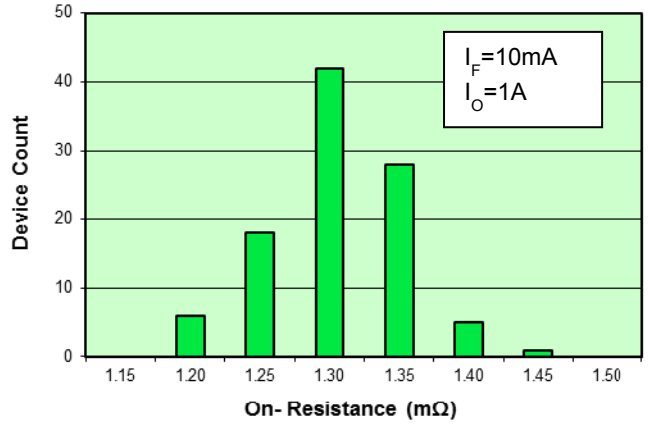


Figure 4: *Typical Output Leakage Current Distribution* (N = 100, T_a = 25ºC)

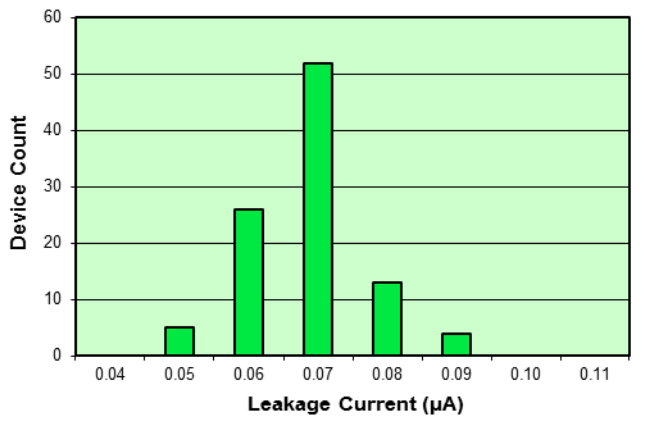


Figure 5: *Typical Blocking Voltage Distribution* (N = 100, Ta = 25ºC)

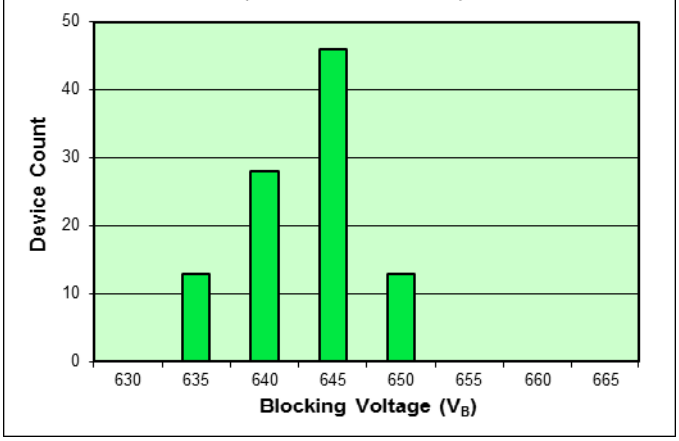
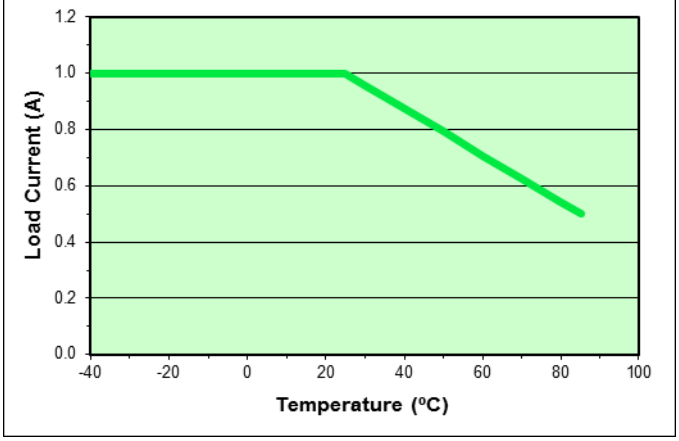


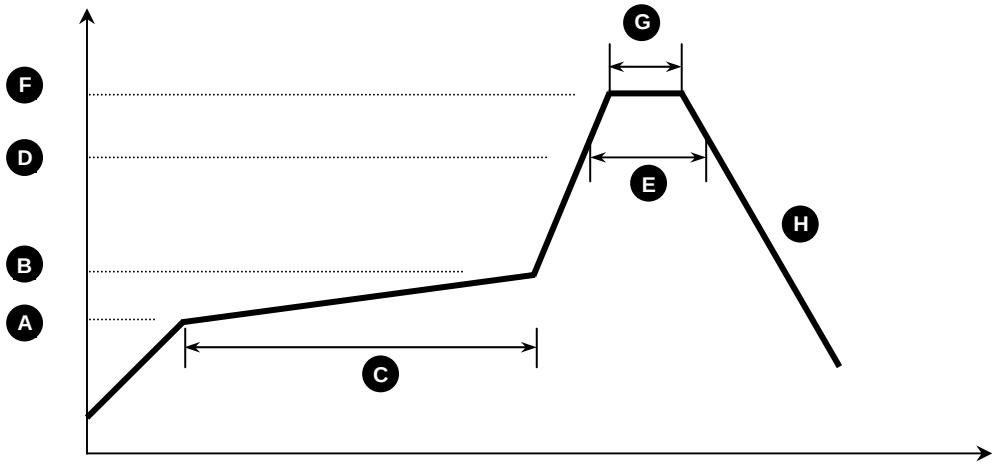
Figure 6: *Maximum Load Current vs. Temperature*



SMA4124 Solder Reflow Temperature Profile Recommendations

(1) *Infrared Reflow:*

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250ºC:



Process Step	Description	Parameter
A	Preheat Start Temperature (ºC)	150ºC
B	Preheat Finish Temperature (ºC)	180ºC
C	Preheat Time (s)	90 - 120s
D	Melting Temperature (ºC)	230ºC
E	Time above Melting Temperature (s)	30s
F	Peak Temperature, at Terminal (ºC)	260ºC
G	Dwell Time at Peak Temperature (s)	10s
H	Cool-down (ºC/s)	<6ºC/s

(2) *Wave Solder:*

Maximum Temperature:	260ºC (at terminal)
Maximum Time:	10s
Pre-heating:	100 - 150ºC (30 - 90s)
Single Occurrence	

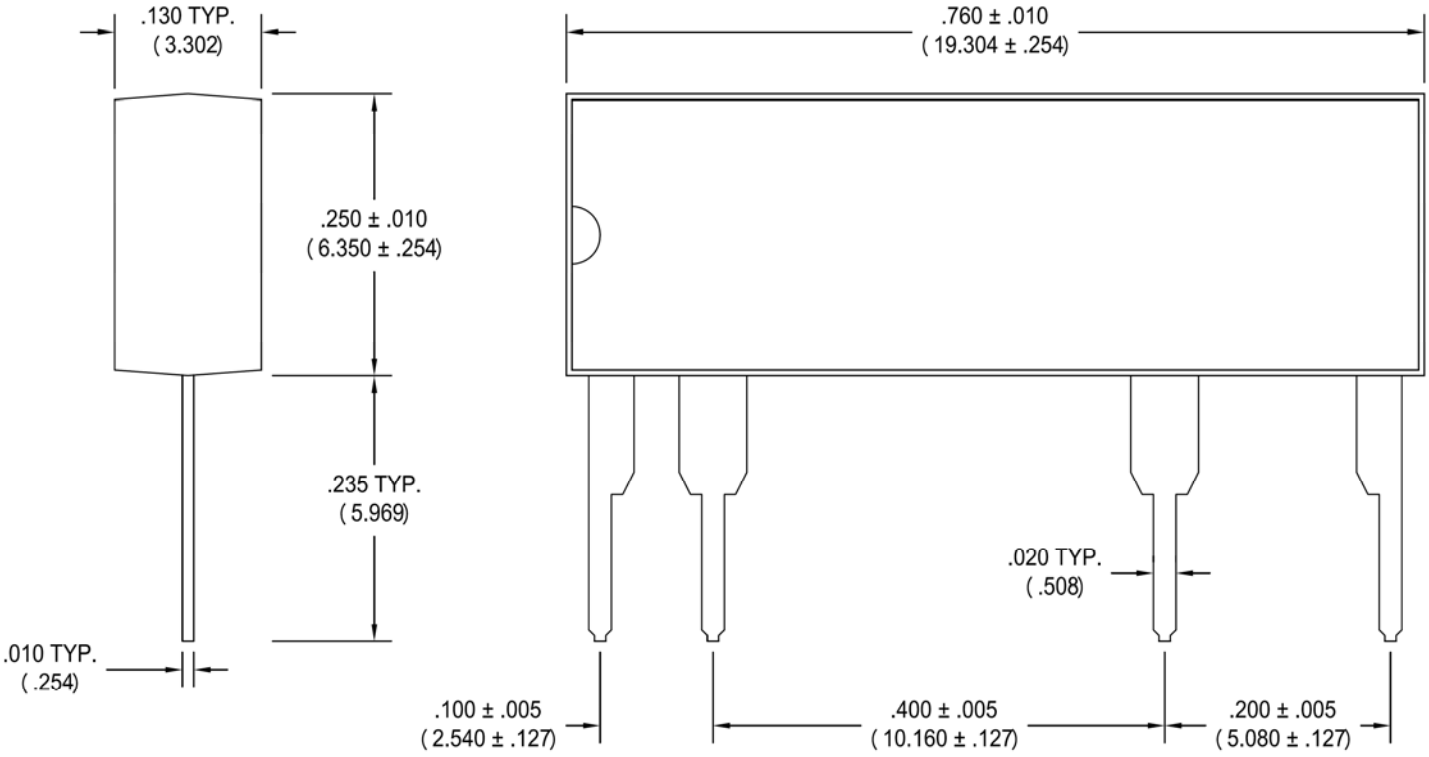
(3) *Hand Solder:*

Maximum Temperature:	350ºC (at tip of soldering iron)
Maximum Time:	3s
Single Occurrence	

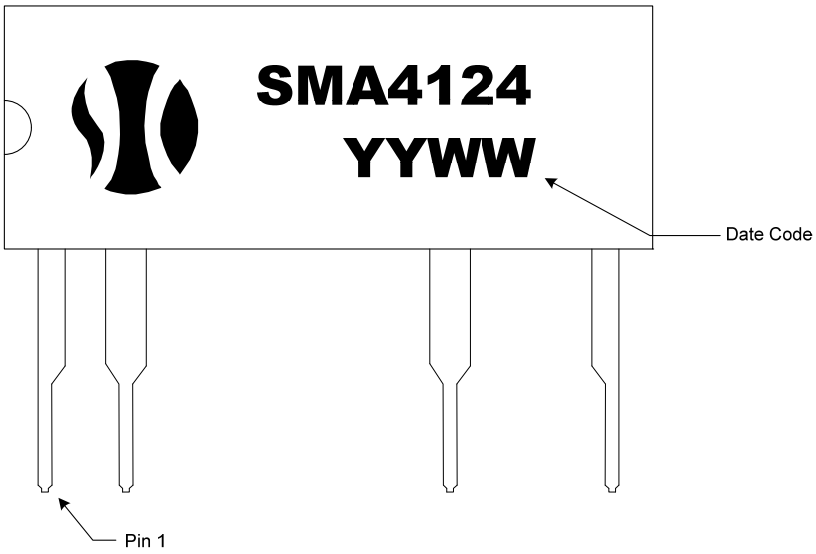
SMA4124 Package Dimensions

4 PIN SIP Package

Note: *All dimensions in inches with millimeters [mm] in parenthesis ()*



SMA4124 Package Marking



SMA4124 Package Weights

Device	Single Unit	Full Tube (25pcs)	Full Pouch (10 tubes)
SMA4124	0.88	35	370

Note: *All weights above are in GRAMS, and include packaging materials where applicable*

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